## 2013/2905(DEA) DEA - Delegated acts procedure Exemption for lead in solders on printed circuit boards, termination coatings of electrical and electronic components and coatings of printed circuit boards, solders for connecting wires and cables, solders connecting transducers and sensors that are used durably at a temperature below –20°C Supplementing 2008/0240(COD)

## **Documentation gateway**

3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage,

Subject

transport)

## **European Commission**

Document type	Reference	Date	Summary
Non-legislative basic document	C(2013)06798	18/10/2013	